

AFBR-735ASMZ

25GbE SFP28 for Multi-Mode Optical Fiber Digital Diagnostic SFP, 850-nm, Low Voltage (3.3V) 25GBASE-SR, 10GBASE-SR Ethernet Optical Transceiver

Description

The Broadcom[®] AFBR-735ASMZ optical transceiver supports high-speed serial links over multi-mode optical fiber at 25.78 Gb/s (the serial line rate of 25GbE). The product is compliant with Small Form Pluggable industry agreements SFP and SFP28 for mechanical and low-speed electrical specifications. High-speed electrical and optical specifications are compliant with IEEE 802.3 for 25GBASE-SR and 10GBASE-SR.

The AFBR-735ASMZ is a 850-nm transceiver that ensures compliance with 25GBASE-SR specifications. Per the requirements of 25GbE, internal clock and data recovery (CDR) circuits are present on both electrical input and electrical output of this transceiver. These CDRs lock at 25.78 Gb/s but must be bypassed for 10GBASE-SR operation using two Rate Select inputs.

Digital diagnostic monitoring information (DMI) is present in the AFBR-735ASMZ per the requirements of SFF-8472, providing real-time monitoring information of transceiver laser, receiver, and environment conditions over a SFF-8419 two-wire serial interface.

Related Products

- AFBR-89CDDZ: 850-nm QSFP28 for 100GBASE-SR4
- AFBR-79EQDZ: 850-nm QSFP+ for 40GBASE-SR4, 100m
- AFBR-79E3PZ: 850-nm QSFP+ for 40GBASE-SR4, 300m
- AFBR-709ISMZ: 850-nm SFP+ for 10GBASE-SR/SW, -40°C/85°C
- AFBR-709SMZ: 850-nm SFP+ for 10GBASE-SR/SW, 0°C/70°C
- AFCT-709SM: 1310-nm SFP+ for 10GBASE-LR, 0°C/ 70°C

Features

- Compliant to RoHS directives
- 850-nm Vertical Cavity Surface Emitting Laser (VCSEL)
- Class 1 eye safe per IEC60825-1 and CDRH
- Wide temperature range (0°C to 85°C)
- LC duplex connector optical interface conforming to ANSI TIA/EIA604-10 (FOCIS 10A)
- Diagnostic features per SFF-8472 "Diagnostic Monitoring Interface for Optical Transceivers"
- Enhanced operational features including variable electrical EQ/emphasis settings
- Real-time monitoring of the following:
 - Transmitter average optical power
 - Received average optical power
 - Laser bias current
 - Temperature
 - Supply voltage
- SFP28 mechanical specifications per SFF-8432
- SFP28-compliant low-speed interface per SFF-8419
- 25GBASE-SR and 10GBASE-SR compliant optical link distances

Applications

- Ethernet switches (director, stand-alone, blade)
- Ethernet NIC cards and adapters
- Port side connections
- Inter-switch or inter-chassis aggregated links

Broadcom AFBR-735ASMZ-DS100
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Transmitter Section

The transmitter section includes a Transmitter Optical Sub-Assembly (TOSA), laser driver circuit, CDR circuit, and an electrical input stage with variable equalization controls. The TOSA contains a 850-nm VCSEL light source with integral light monitoring function and imaging optics to ensure efficient optical coupling to the LC connector interface. The TOSA is driven by a laser driver IC, which uses the differential output from an integral Tx CDR stage to modulate and regulate VCSEL optical power. As mandated by IEEE 802.3, the integral CDR cleans up any incoming jitter accumulated from the host ASIC, PCB traces, and SFP electrical connector. Between the SFP electrical connector and Tx CDR is a variable, two-wire serial-controlled equalization circuit to optimize SFP performance with nonideal incoming electrical waveforms.

Receiver Section

The receiver section includes a Receiver Optical Sub-Assembly (ROSA), pre-amplification and post-amplification circuit, CDR circuit, and an electrical output stage with variable emphasis controls. The ROSA, containing a high-speed PIN detector, pre-amplifier and imaging optics efficiently couple light from the LC connector interface and perform an optical to electrical conversion. The resulting differential electrical signal passes through a

post amplification circuit and into a CDR circuit for cleaning up accumulated jitter.

Note the Tx and Rx CDR is engaged with TX/RX Rate Select = high (25GbE) and disengaged (bypassed) with RATE Select = low (other data rates, such as 10GbE).

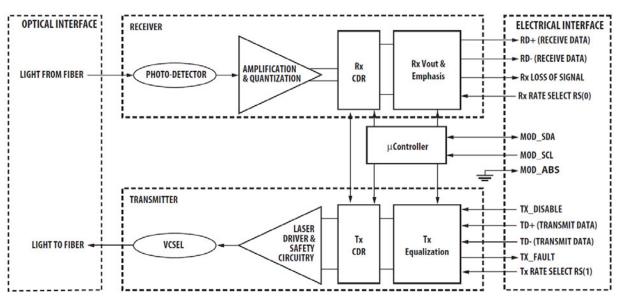
Digital Diagnostics

The AFBR-735ASMZ is compliant to the Diagnostic Monitoring Interface (DMI) defined in document SFF-8472. These features allow the host to access, using two-wire serial, real-time diagnostic monitors of transmit optical power, received optical power, temperature, supply voltage, and laser operating current.

Low-Speed Interfaces

Conventional low-speed interface I/Os are available as defined in the SFF-8419 document to manage coarse and fine functions of the optical transceiver. On the transmit side, a Tx_DISABLE input is provided for the host to turn on and turn off the outgoing optical signal. A transmitter fault indicator output, Tx_FAULT, is available for the SFP to signal a host of a transmitter operational problem. A received optical power loss of signal indicator, RX_LOS, is available to advise the host of a receiver operational problem, such as a low optical input condition.

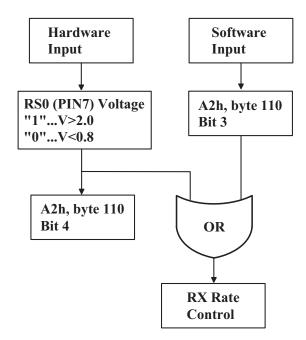




Rate Select Control

RX and TX rates can be independently controlled by either hardware input pins or using register writes. Module electrical input pins 7 and 9 are used to select RX and TX rates, respectively. Status of each logic level is reflected to register byte 110 bit 4 and 5 on address A2h as shown in Figure 2. RX and TX rates can also be controlled by register writes to byte 110 bit 3 and 118 bit 3. The power-on default of these bits is logic low. Hardware and software control inputs are ORed to allow flexible control.

Figure 2: Rate Select Control RS0 RX Rate Select Control Flow



RS1 TX Rate Select Control Flow

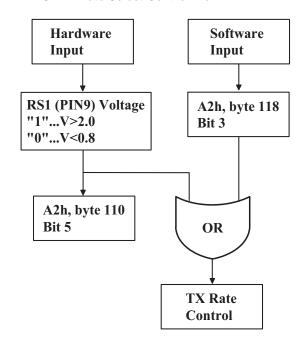


Table 1: Rate Select Control

RS0 Co	ontrol Input				
Hardware Pin 7	A2h Byte 110 Bit 3	RX Operation			
0 ^a	0 ^a	10G ^a RX CDR bypassed ^a			
0	1	25G	RX CDR enabled		
1	0	25G			
1	1	25G			

RS1 Co	ontrol Input	TX Operation			
Hardware Pin 9	A2h Byte 118 Bit 3				
0	0	10G TX CDR bypassed ^a			
0	1	25G	TX CDR enabled		
1	09	25G			
1	1	25G			

a. Factory default condition per MSA SFF-8472 is 10G mode; Module software rate select registers are set to 0 and hardware pins 7 and 9 are internally pulled to GND using 40 kΩ. The host board must actively change hardware, software, or both logic levels for 25G operation.

Table 2: Regulatory Compliance

Feature	Test Method	Performance
Electrostatic Discharge (ESD) to the Electrical Contacts	JEDEC Human Body Model (HBM) (JESD22-A114-B)	High-speed contacts withstand 1000V. All other contacts withstand 2000V.
Electrostatic Discharge (ESD) to the Optical Connector Receptacle	EN61000-4-2, Criterion B	When installed in a properly grounded housing and chassis the units are subjected to 15-kV air discharges during operation and 8-kV direct discharges to the case.
Electromagnetic Interference (EMI)	FCC Part 15 CENELEC EN55022 (CISPR 22A) VCCI Class 1	System margins are dependent on customer board and chassis design.
Immunity	Variation of IEC 61000-4-3	Typically shows no measurable effect from a 10-V/m field set from 80 MHz to 1 GHz applied to the module without a chassis enclosure
Laser Eye Safety and Equipment Type Testing BAUART GEPRUFT TOV Rheinland Product Safety APPROVED	US FDA CDRH AEL Class 1 US21 CFP, Subchapter J per Paragraphs 1002.10 and 1002.12 (IEC) EN60825-1:1994 +A11 +A2 (IEC) EN60825-2:1994 +A1 (IEC) EN60950:1992 +A1 +A2 +A3 +A4 +A11	CDRH Certification 9720151-155 TUV File: R72121699
Component Recognition	Underwriters Laboratories (UL) and Canadian Standards Association (CSA) Joint Component Recognition for Information Technology Equipment including Electrical Business Equipment	UL File: E173874
RoHS Compliance		Less than 1000 ppm of cadmium, lead, mercury, hexavalent chromium, polybrominated biphenyls (PPBs) and polybrominated biphenyl ethers (PBDEs).

Figure 3: Typical Application Configuration

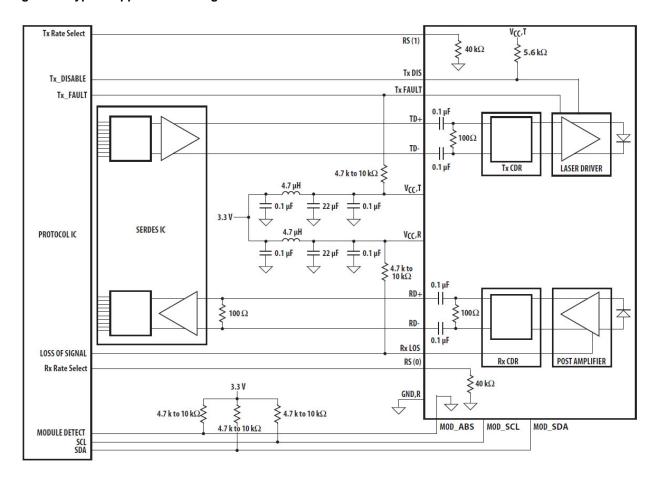
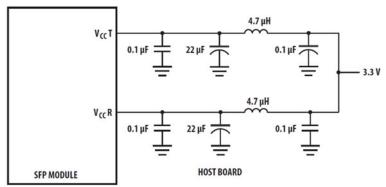


Figure 4: Recommended Power Supply Filter



NOTE: INDUCTORS MUST HAVE LESS THAN 0.5Ω Series resistance to limit voltage drop to the SFP module.

Table 3: Pin Description

Pin	Name	Function/Description	Notes
1	VeeT	Transmitter Ground	
2	TX_FAULT	Transmitter Fault Indication – High indicates a fault condition	а
3	TX_DISABLE	Transmitter Disable – Module optical output disables on high or open	b
4	MOD_SDA	Module Definition 2 – Two-wire serial ID interface data line (SDA)	С
5	MOD_SCL	Module Definition 1 – Two-wire serial ID interface clock line (SCL)	С
6	MOD_ABS	Module Definition 0 – Grounded in module (module present indicator)	С
7	Rx Rate Select, RS(0)	0 for 10GbE, 1 for 25GbE operation	d
8	RX_LOS	Loss of Signal – High indicates loss of received optical signal	е
9	Tx Rate Select, RS(1)	0 for 10GbE, 1 for 25GbE operation	d
10	VeeR	Receiver Ground	
11	VeeR	Receiver Ground	
12	RD-	Inverse Received Data Out	f
13	RD+	Received Data Out	f
14	VeeR	Receiver Ground	
15	VccR	Receiver Power + 3.3V	g
16	VccT	Transmitter Power + 3.3V	g
17	VeeT	Transmitter Ground	
18	TD+	Transmitter Data In	h
19	TD-	Inverse Transmitter Data In	h
20	VeeT	Transmitter Ground	

- a. TX_FAULT is an open collector/drain output, which must be pulled up with a $4.7-k\Omega$ to $10-k\Omega$ resistor on the host board. When high, this output indicates a laser fault of some kind. Low indicates normal operation. In the low state, the output is pulled to < 0.8V.
- b. $TX_DISABLE$ is an input that shuts down the transmitter optical output. It is internally pulled up (within the transceiver) with a 5.6-k Ω resistor.

Low (0V to 0.8V)

Transmitter on

Between (0.8V and 2.0V):

Undefined

High (2.0V to Vcc max.) or OPEN: Transmitter Disabled

- c. The signals Mod_ABS, SCL, SDA designate the two-wire serial interface pins. They must be pulled up with a 4.7-kΩ to 10-kΩ resistor on the host board.
 - Mod ABS is grounded by the module to indicate the module is present.
 - Mod_SCL is serial clock line (SCL) of two-wire serial interface.
 - Mod_SDA is serial data line (SDA) of two-wire serial interface.
- d. Rate select input is used to control CDR. It is internally pulled down with a $40-k\Omega$ resistor.
- e. RX_LOS (Rx Loss of Signal) is an open collector/drain output that must be pulled up with a 4.7-kΩ to 10-kΩ resistor on the host board. When high, this output indicates the received optical power is below the worst case receiver sensitivity (as defined by the standard in use). Low indicates normal operation. In the low state, the output is pulled to < 0.8V.
- f. RD-/+ designate the differential receiver outputs. They are AC coupled 100Ω differential lines that should be terminated with 100Ω differential at the host SerDes input. AC coupling is done inside the transceiver and is not required on the host board. The voltage swing on these lines is between 50 mV and 900 mV differential (25-mV to 450-mV single-ended) when properly terminated.
- g. VccR and VccT are the receiver and transmitter power supplies. Refer to SFF-8419 for the details.
- h. TD-/+ designate the differential transmitter inputs. They are AC coupled differential lines with 100Ω differential termination inside the module. The AC coupling is done inside the module and is not required on the host board. The inputs accept differential swings of 40 mV to 1200 mV (20-mV to 600-mV single-ended), although use values between 50 mV and 900 mV differential (25-mV to 450-mV single-ended) for best EMI performance.

Stress in excess of any of the individual Absolute Maximum Ratings can cause immediate catastrophic damage to the module even if all other parameters are within Recommended Operating Conditions. It should not be assumed that limiting values of more than one parameter can be applied to the module concurrently. Exposure to any of the Absolute Maximum Ratings for extended periods can adversely affect reliability.

Table 4: Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Units	Notes
Storage Temperature	T _S	-40	85	°C	а
Case Operating Temperature	T _C	-40	85	°C	
Relative Humidity	RH	5	95	%	
Supply Voltage	V _{CC}	-0.5	3.63	V	
Low Speed Input Voltage	VI	-0.5	VCC + 0.5, 3.63	V	

a. Absolute Maximum Ratings are those values beyond which damage to the device may occur if these limits are exceeded for other than a short period of time. Refer to the reliability data sheet for specific reliability performance. Between Absolute Maximum Ratings and the Recommended Operating Conditions, functional performance is not intended, device reliability is not implied, and damage to the device may occur over an extended period of time.

Recommended Operating Conditions specify parameters for which the optical and electrical characteristics hold unless otherwise noted. Optical and electrical characteristics are not defined for operation outside the Recommended Operating Conditions, reliability is not implied and damage to the module may occur for such operation over an extended period of time.

Table 5: Recommended Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Units	Notes
Case Operating Temperature	T _C	0	_	85	°C	а
Supply Voltage	V _{CC}	3.135	3.3	3.465	V	
Data Rate		10.3125	_	25.78125	Gb/s	b
Two-Wire Serial (TWS) Interface Clock Rate		_	_	400	kHz	С

- a. The position of the case temperature measurement is shown in Figure 8. Continuous operation at the maximum recommended case operating temperature should be avoided not to degrade reliability.
- b. 25GbE requires FEC RS(528.514) encoding per IEEE 802.3.
- c. With 500-µs clock stretch per SFF-8419.

The following characteristics are defined per the Recommended Operating Conditions unless otherwise noted.

Table 6: Transceiver Electrical Characteristics

Parameter	Symbols	Min.	Тур.	Max.	Units	Notes
Transceiver Power Consumption		_	_	1.0	W	
Transceiver Power Supply Current		_	_	319	mA	
Power Supply Noise Rejection (Peak-Peak)	PSNR	_	_	66	mV	а
TX_FAULT, RX_LOS	I _{OH}	-50	_	37.5	μA	b
	V _{OL}	-0.3	_	0.4	V	
TX_DIS, RS(0), RS(1)	V _{IH}	2.0	_	V _{CC} + 0.3		
	V _{IL}	-0.3	_	0.8	V	
MOD_SCL, MOD_SDA	V _{OH}	VCC_Host - 0.5	_	VCC_Host + 0.3	V	С
	V _{OL}	0.0	_	0.4	V	
	V _{IH}	VCCT × 0.7	_	VCCT + 0.5	V	
	V _{IL}	-0.3	_	VCCT × 0.3	V	

- a. Filter per SFP specification is required on the host board to remove 10-Hz to 2-MHz content.
- b. Measured with a 4.7-k Ω load pulled up to the host board to 3.3V.
- c. Mod_SCL and Mod_SDA must be pulled up externally with a 4.7-k Ω to 10-k Ω resistor on the host board to host V_{CC} (3.14 < VCC_Hst < 3.46V).

Table 7: High-Speed Electrical Module Input Characteristics

Parameter	Test Point	Min.	Тур.	Max.	Units	Notes/Conditions
Signaling Rate	TP1	_	25.78125	_	Gbaud	± 100 ppm
Differential Pk-Pk Input Voltage Tolerance	TP1a	900	_	_	mV	
Differential Input Return Loss, Min.	TP1	_	Eq 83E-5	_	dB	IEEE 802.3bm
Common Mode to Differential Input Return Loss, Min.	TP1	_	Eq 83E-6	_	dB	IEEE 802.3bm
Differential Termination Mismatch	TP1	_	_	10	%	
Module Stressed Input Test	TP1a	_	83E.3.4.2	_		IEEE 802.3bm, below
Single-Ended Voltage Tolerance Range	TP1a	-0.4	_	3.3	V	
DC Common Mode Output Voltage	TP1a	-0.350	_	2.85	V	Note ^a
LOS Hysteresis		0.5	_	4	dB	Note ^b

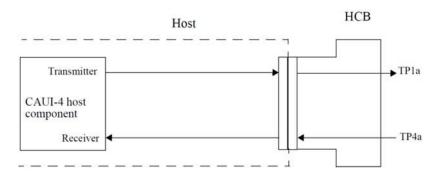
Parameter	Value	Units	Notes/Conditions
Module Stressed Input Test			Note ^c
Eye Width	0.46	UI	
Applied Pk-Pk Sinusoidal Jitter	Table 88-13		
Eye Height	95	mV	

- a. DC common mode voltage generated by the host. The specification includes effects of ground offset voltage.
- b. LOS Hysteresis is defined as 20 × Log(LOS Deassert Level / LOS Assert Level).
- c. Module stressed input tolerance is measured using the procedure defined in 83E.3.4.1.1

Table 8: Reference Points

Test Point	Description
TP0	Host ASIC transmitter output at the ASIC package pin on a DUT board.
TP1	Input to the module compliance board through the mated module compliance board and the module connector. Used to test module input.
TP1A	Host ASIC transmitter output across the host board and the host edge card connector at the output of the host compliance board.
TP2	Optical transmitter output as measured at the end of a 2m to 5m patch cord mated to the optical module.
TP3	Optical test point as measured at the end of an optical fiber cable; closest point to the presumed optical receiver input.
TP4	Module output through the mated module and the host edge card connector through the module compliance board.
TP4A	Input to the host compliance board through the mated host compliance board and the host edge card connector. Used to test host input.
TP5	Input to the host ASIC.

Figure 5: IEEE 802.3bm CAUI-4 Compliance Points TP1a, TP4a



Note a reference receiver is used to measure host eye width and eye height at TP1a. The reference receiver includes a selectable continuous time linear equalizer (CTLE) which is described by Equation (83-4) with coefficients given in Table 83E-2 – Reference CTLE Coefficients.

Equation (83-4)

$$H(f) = (G \times P_1 \times P_2) / Z_1$$

where:

H(f) is the CTLE transfer function, f is the frequency in GHz

G is the CTLE gain

P1, P2 are the CTLE poles in Grad/s

Z1 is the CTLE zero in Grad/s

Table 83E-2 - Reference CTLE Coefficients

Peaking (dB)	G	P ₁ /2π	P ₂ /2π	Ζ ₁ /2π
1	0.89125	18.6	14.1	8.364
2	0.79433	18.6	14.1	7.099
3	0.70795	15.6	14.1	5.676
4	0.63096	15.6	14.1	4.9601
5	0.56234	15.6	14.1	4.358
6	0.50119	15.6	14.1	3.844
7	0.44668	15.6	14.1	3.399
8	0.39811	15.6	14.1	3.012
9	0.35481	15.6	14.1	2.672

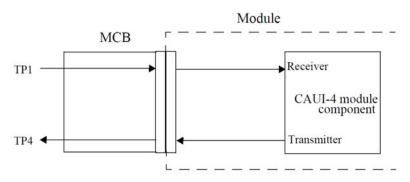
From 25G AUI C2M Clause 109B. The following characteristics are defined over the Recommended Operating Conditions unless otherwise noted.

Table 9: High-Speed Electrical Module Output Characteristics

Parameter	Test Point	Min.	Тур.	Max.	Units	Notes/Conditions
Signaling Rate	TP4	_	25.78125	_	Gbaud	± 100 ppm
Common Mode AC Output Voltage, RMS	TP4	_	_	17.5	mV, rms	
Differential Output Voltage	TP4	_	_	900	mV	
Eye Width	TP4	0.57	_	_	UI	
Eye Height, Differential	TP4	228	_	_	mV	
Vertical Eye Closure	TP4	_	_	5.5	dB	
Differential Output Return Loss, Min.	TP4	_	Eq 83E-2	_	dB	IEEE 802.3bm
Common to Differential Mode Conversion, Min.	TP4	_	Eq 83E-3	_	dB	IEEE 802.3bm
Differential Termination Mismatch	TP4	_	_	10	%	
Transition Time (20% to 80%)	TP4	12	_	_	ps	
DC Common Mode Voltage	TP4	-0.35	_	2.85	V	Note ^a

a. DC common mode voltage is generated by the host. The specification includes effects of ground offset voltage.

Figure 6: IEEE 802.3bm CAUI-4 Compliance Points TP1, TP4



From 25GBASE-SR, IEEE 802.3by Clause 112. The following characteristics are defined over the Recommended Operating Conditions unless otherwise noted.

Table 10: High-Speed Optical Transmitter Characteristics

Parameter	Test Point*	Min.	Тур.	Max.	Units	Notes/Conditions
Signaling Rate		_	25.78125	_		± 100 ppm
Center Wavelength Range	TP2	840	_	860	nm	
RMS Spectral Width	TP2	_	_	0.60	nm	Note ^a
Average Launch Power	TP2	-8.4	_	+2.4	dBm	
Optical Modulation Amplitude (OMA)	TP2	-6.4	_	+3.0	dBm	Note ^b
Launch Power in OMA Minus TDEC	TP2	-7.3	_	_	dBm	
Transmitter and Dispersion Eye Closure (TDEC)	TP2	_	_	4.3	dB	
Average Launch Power of OFF Transmitter	TP2	_	_	-30	dBm	
Extinction Ratio	TP2	2	_	_	dB	
Optical Return Loss Tolerance	TP2	_	_	12	dB	
Encircled Flux	TP2	≥ 86% at 19 µm				Note ^c
		≤ 30% at 4.5 µm				
Transmitter Eye Mask Definition: {X1, X2, X3, Y1, Y2, Y3}	TP2	{0.3	Specificatior , 0.38, 0.45, 0		}	Hit ratio 1.5 × 10 ⁻³ hits per sample

- a. RMS spectral width is the standard deviation of the spectrum.
- b. Even if the TDEC < 0.9 dB, the OMA (min.) must exceed this value.
- c. If measured into type A1a.2 50-µm fiber in accordance with IEC 61280-1-4.

Figure 7: Transmitter Eye Mask Definitions

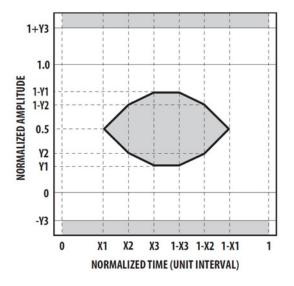


Table 11: High-Speed Optical Transmitter Characteristics, TX Rate Select = Low

Parameter	Test Point*	Min.	Тур.	Max.	Units	Notes/Conditions
Signaling Rate		_	10.3125	_		± 100 ppm
Laser OMA Output Power	TP2	-4.3	_	_	dBm	Note ^a
Laser Mean Output Power	TP2	_	_	0	dBm	
Laser off Power	TP2	_	_	-30	dBm	
Extinction Ratio	TP2	3.0	_	_	dBm	
Transmitter and Dispersion Penalty (TDP)	TP2	_	_	3.9	dB	
Center Wavelength	TP2	840	_	860	nm	Note ^a
RMS Spectral Width, Standard Deviation	TP2	_	_	-30	dBm	Note ^a
RIN12OMA	TP2	3	_	-128	dB/Hz	
Optical Return Loss Tolerance	TP2	_	_	12	dB	

a. Trade-offs are available among spectral width, center wavelength, and minimum optical modulation amplitude per IEEE 802.3.

From 25GBASE-SR, IEEE 802.3by Clause 112. The following characteristics are defined over the Recommended Operating Conditions unless otherwise noted.

Table 12: High-Speed Optical Receiver Characteristics

Parameter	Test Point*	Min.	Тур.	Max.	Units	Notes/Conditions
Signaling Rate		_	25.78125	_		± 100 ppm
Center Wavelength Range		840	_	860	nm	
Damage Threshold		+3.4	_	_	dBm	Note ^a
Average Receive Power		-10.3	+2.4	+2.4	dBm	Note ^b
Receive Power (OMA)		_	_	+3.0	dBm	
Receiver Reflectance		_	_	-12	dB	
Stressed Receiver Sensitivity OMA		_	_	-5.2	dBm	Note ^c
Conditions of Stressed Receiver Sensitivity Test		_	_	_		Note ^d
Stressed Eye Closure (SEC)		_	4.3	_	dB	
Stressed Eye J2 Jitter		_	0.39	_	UI	
Stressed Eye J4 Jitter		_	0.53	_	UI	
Stressed Receiver Eye Mask Definition: X1, X2, X3, Y1,Y2, Y3		+	Specific (0.28, 0.50, 0.5	ation Values 50, 0.33, 0.33	, 0.40}	Hit ratio 5 × 10 ⁻⁵ hits per sample
Parameter	Test Point*	Min.	Тур.	Max.	Units	Notes/Conditions
LOS Assert	TP3	-30	_	_	dBm,avg	
LOS Deassert	TP3	_	_	-9.1	dBm,avg	
LOS Hysteresis	TP3	0.5	_	_	dB	

a. The receiver is able to tolerate, without damage, continuous exposure to a modulated optical input signal having this power level. The receiver does not have to operate correctly at this input power.

- c. Measured with conformance test signal at TP3 (see IEEE 802.3bm Section 95.8.8) for BER specified in IEEE 802.3bm Section 95.1.1.
- d. These test conditions are for measuring stressed receiver sensitivity. They are not characteristics of the receiver.

b. Average receive power (min.) is informative and not the principal indicator of signal strength. A received power below this value cannot be compliant; however, a value above this does not ensure compliance.

Table 13: High-Speed Optical Receiver Characteristics, RX Rate Select = Low

Parameter	Test Point*	Min.	Тур.	Max.	Units	Notes/Conditions
Signaling Rate			10.3125	_		± 100 ppm
Stressed Sensitivity (OMA)		-	_	-7.5	dBm	
Receive Sensitivity (OMA)		_	_	-11.1	dBm	
Receive Power Overload		-1.0	_	_	dBm	
Receiver Reflectance		-	_	-12	dB	
Center Wavelength		840	_	860	nm	
RX_LOS Assert		-30	_	_	dBm,avg	
RX_LOS Deassert			_	-9.1	dBm,avg	
RX_LOS Hysteresis		0.5	_	_	dB	
Vertical Eye Closure Penalty		3.5	_	_	dB	
Stressed Eye Jitter		-0.3	_	_	Ulp-p	

Table 14: Transceiver Soft Diagnostic Timing Characteristics

Parameter	Symbol	Min.	Max.	Unit	Notes
Hardware TX_DISABLE Assert Time	t_off		10	μs	а
Hardware TX_DISABLE Negate Time	t_on	_	1	ms	b
Time to Initialize, Including Reset of TX_FAULT	t_init	_	300	ms	С
Hardware TX_FAULT Assert Time	t_fault	_	100	μs	d
Hardware TX_DISABLE to Reset	t_reset	10	_	μs	е
Hardware RX_LOS Deassert Time	t_loss_on	_	100	μs	f
Hardware RX_LOS Assert Time	t_loss_off	_	100	μs	g
Hardware RATE_SELECT Change Time	t_ratesel	_	10	μs	
Software TX_DISABLE Assert Time	t_off_soft	_	100	ms	h
Software TX_DISABLE Negate Time	t_on_soft	_	100	ms	i
Software Tx_FAULT Assert Time	t_fault_soft		100	ms	j
Software Rx_LOS Assert Time	t_loss_on_soft	_	100	ms	k
Software Rx_LOS Deassert Time	t_loss_off_soft	_	100	ms	I
Serial Bus Diagnostic Data Ready	t_data	_	1000	ms	m
Serial Bus Hardware Ready	t_serial	_	300	ms	n
Serial Bus Buffer Time	t_buf	20	_	μs	0
Complete Single or Sequential Write Up to 4 Bytes	twR	_	40	ms	р
Complete Sequential Write of 5 to 8 Bytes	twR	_	80	ms	
Serial Interface Clock Holdoff "Clock Stretching"	T_clock_hold	_	500	μs	q
Serial ID Clock Rate	f_serial_clock	_	400	kHz	r

- a. Time from rising edge of TX_DISABLE to when the optical output falls below 10% of nominal.
- b. Time from falling edge of TX_DISABLE to when the modulated optical output rises above 90% of nominal.
- c. Time from power on or falling edge of Tx_Disable to when the modulated optical output rises above 90% of nominal.

d. From occurrence of fault to assertion of TX_FAULT.

- e. Time TX_DISABLE must be held high to reset the laser fault shutdown circuitry.
- f. Time from loss of optical signal to Rx_LOS Assertion.
- g. Time from valid optical signal to Rx_LOS Deassertion.
- h. Time from two-wire interface assertion of TX_DISABLE (A2h, byte 110, bit 6) to when the optical output falls below 10% of nominal. Measured from falling clock edge after stop bit of write transaction.
- i. Time from two-wire interface deassertion of TX_DISABLE (A2h, byte 110, bit 6) to when the optical output rises above 90% of nominal.
- j. Time from fault to two-wire interface TX_FAULT (A2h, byte 110, bit 2) asserted.
- k. Time for two-wire interface assertion of Rx_LOS (A2h, byte 110, bit 1) from loss of optical signal.
- I. Time for two-wire interface deassertion of Rx_LOS (A2h, byte 110, bit 1) from presence of valid optical signal.
- m. From power on to data ready bit asserted (A2h, byte 110, bit 0). Data ready indicates analog monitoring circuitry is functional.
- n. Time from power on until module is ready for data transmission over the serial bus (reads or writes over A0h and A2h).
- o. Time between START and STOP commands.
- p. Time from stop bit to completion of a 1 to 8 byte write command.
- q. Maximum time the SFP+ module may hold the SCL line low before continuing with a read or write operation.
- r. With a maximum clock stretch of 500 µs. A maximum of100-kHz operation can be supported without a clock stretch.

Table 15: Transceiver Digital Diagnostic Monitor (Real Time Sense) Characteristics

Parameter	Symbol	Min.	Units	Notes
Transceiver Internal Temperature Accuracy	T _{INT}	±3.0	°C	Temperature is measured internal to the transceiver. Valid from 0°C to 85°C case temperature.
Transceiver Internal Supply Voltage Accuracy	V _{INT}	± 0.1	V	Supply voltage is measured internal to the transceiver and can, with less accuracy, be correlated to voltage at the SFP V_{CC} pin. Valid over 3.3V \pm 5%.
Transmitter Laser DC Bias Current Accuracy	I _{INT}	± 10	%	I _{INT} is better than ± 10% of the nominal value.
Transmitted Average Optical Output Power Accuracy	P _T	± 3.0	dB	Coupled into 50-µm multi-mode fiber. Valid from –8.4 dBm to +2.4 dBm avg.
Received Optical Input Power Accuracy	P_{R}	± 3.0	dB	Coupled from 50-µm multi-mode fiber. Valid from –10.3 dBm to +2.4 dBm avg.

Table 16: EEPROM Serial ID Memory Contents - Address A0h

Byte Number Decimal	Hex	Description	Byte Number Decimal	Hex	Description
0	03	SFP physical device	37	00	Hex Byte of Vendor OUI ^a
1	04	SFP function defined by serial ID only	38	17	Hex Byte of Vendor OUI ^a
2	07	LC optical connector	39	6A	Hex Byte of Vendor OUI ^a
3	00		40	41	"A" – Vendor Part Number ASCII Character
4	00		41	46	"F" – Vendor Part Number ASCII Character
5	00		42	42	"B" – Vendor Part Number ASCII Character
6	00		43	52	"R" – Vendor Part Number ASCII Character
7	00		44	2D	"-" – Vendor Part Number ASCII Character
8	00		45	37	"7" – Vendor Part Number ASCII Character
9	00		46	33	"3" – Vendor Part Number ASCII Character
10	00		47	35	"5" – Vendor Part Number ASCII Character

Table 16: EEPROM Serial ID Memory Contents – Address A0h (Continued)

Byte Number Decimal	Hex	Description	Byte Number Decimal	Hex	Description
11	07	256B/257B (transcoded FEC-enabled data)	48	41	"A" – Vendor Part Number ASCII Character
12	FF	Greater than 25.5 Gb/s (see Address 66)	49	53	"S" – Vendor Part Number ASCII Character
13	00		50	4D	"M" – Vendor Part Number ASCII Character
14	00		51	5A	"Z" – Vendor Part Number ASCII Character
15	00		52	20	" " – Vendor Part Number ASCII Character
16	00		53	20	" " – Vendor Part Number ASCII Character
17	00		54	20	" " – Vendor Part Number ASCII Character
18	0A	100m of OM4 50/125-µm fiber at 25GbE	55	20	" " – Vendor Part Number ASCII Character
19	07	70m of OM3 50/125-µm fiber at 25GbE	56	20	" " – Vendor Revision ASCII Character
20	41	"A" – Vendor Name ASCII Character	57	20	" " – Vendor Revision ASCII Character
21	56	"V" – Vendor Name ASCII Character	58	20	" " – Vendor Revision ASCII Character
22	41	"A" – Vendor Name ASCII Character	59	20	" " – Vendor Revision ASCII Character
23	47	"G" – Vendor Name ASCII Character	60	03	Hex Byte of Laser Wavelength ^b
24	4F	"O" – Vendor Name ASCII Character	61	52	Hex Byte of Laser Wavelength ^b
25	20	" " – Vendor Name ASCII Character	62	00	
26	20	" " – Vendor Name ASCII Character	63		Checksum for Bytes 0 to 62 ^c
27	20	" " – Vendor Name ASCII Character	64	08	CDRs present. 1W power class
28	20	" " – Vendor Name ASCII Character	65	3A	Hardware Tx_Disable, Tx_Fault, Rx_LOS, Rate_Select
29	20	" " – Vendor Name ASCII Character	66	67	25.78 Gb/s nominal bit rate (25GbE)
30	20	" " – Vendor Name ASCII Character	67	00	
31	20	" " – Vendor Name ASCII Character	68–83		Vendor Serial Number ASCII characters ^d
32	20	" " – Vendor Name ASCII Character	84–91		Vendor Date Code ASCII characters ^e
33	20	" " – Vendor Name ASCII Character	92	68	Digital diagnostics, Internal Cal, Rx Pwr Avg
34	20	" " – Vendor Name ASCII Character	93	FA	Alarms/Warnings, Software Tx_Disable, Tx-Fault, Rx_LOS, Rate_Select
35	20	" " – Vendor Name ASCII Character	94	80	SFF-8472 compliance to revision 12.2
36	02	25GBASE-SR	95		Checksum for Bytes 62 to 94 ^c
			96–255	00	

- a. The IEEE Organizationally Unique Identified OUI) assigned to Broadcom is 00-17-6A (3 bytes of hex).
- b. Laser wavelength is represented in 16 unsigned buts. The hex representation of 850 nm is 0352.
- c. Addresses 63 and 95 are checksums calculated (per SFF-8472 and SFF-8074) and stored prior to product shipment.
- d. Addresses 68–83 specify the AFBR-735ASMZ ASCII serial number and vary on a per-unit basis.
- e. Addresses 84–91 specify the AFBR-735ASMZ ASCII data code and vary on a per-date code basis.

Table 17: EEPROM Serial ID Memory Contents - Enhanced SFP Memory (Address A2h)

Byte Number Decimal	Notes	Byte Number Decimal	Notes	Byte Number Decimal	Notes
0	Temp H Alarm MSB ^a	26	Tx Power L Alarm MSB ^g	104	Real Time Rx Power MSB ^b
1	Temp H Alarm LSB ^a	27	Tx Power L Alarm LSB ^g	105	Real Time Rx Power LSB ^b
2	Temp L Alarm MSB ^a	28	Tx Power H Warning MSB ^g	106	Reserved
3	Temp L Alarm LSB ^a	29	Tx Power H Warning LSB ^g	107	Reserved
4	Temp H Warning MSB ^a	30	Tx Power L Warning MSB ^g	108	Reserved
5	Temp H Warning LSB ^a	31	Tx Power L Warning LSB ^g	109	Reserved
6	Temp L Warning MSB ^a	32	Rx Power H Alarm MSB ^b	110	Status/Control – See Table 18
7	Temp L Warning LSB ^a	33	Rx Power H Alarm LSB ^b	111	Reserved
8	Vcc H Alarm MSB ^c	34	Rx Power L Alarm MSB ^b	112	Flag Bits – See Table 19
9	Vcc H Alarm LSB ^c	35	Rx Power L Alarm LSB ^b	113	Flag Bits –See Table 19
10	Vcc L Alarm MSB ^c	36	Rx Power H Warning MSB ^b	114	Tx Input EQ Control – See Table Table 22, Table 23
11	Vcc L Alarm LSB ^c	37	Rx Power H Warning LSB ^b	115	Rx Output Emphasis Control – See Table 24, Table 25
12	Vcc H Warning MSB ^c	38	Rx Power L Warning MSBb	116	Flag Bits – See Table 19
13	Vcc H Warning LSB ^c	39	Rx Power L Warning LSB ^b	117	Flag Bits – See Table 19
14	Vcc L Warning MSB ^c	40–55	Optional Alarm and Warning	118	Status/Control – See Table 20
15	Vcc L Warning LSB ^c	56–94	External Calibration Constants ^d	119	CDR Loss of Lock Status – See Table 21
16	Tx Bias H Alarm MSB ^e	95	Checksum for Bytes 0 to 94 ^f	120–127	Reserved
17	Tx Bias H Alarm LSB ^e	96	Real Time Temperature MSB ^a	128–247	Customer Writable
18	Tx Bias L Alarm MSB ^e	97	Real Time Temperature LSB ^a	248–255	Vendor Specific
19	Tx Bias L Alarm LSB ^e	98	Real Time Vcc MSB ^c		
20	Tx Bias H Warning MSB ^e	99	Real Time Vcc LSB ^c		
21	Tx Bias H Warning LSB ^e	100	Real Time Tx Bias MSB ^e		
22	Tx Bias L Warning MSB ^e	101	Real Time Tx Bias LSB ^e		
23	Tx Bias L Warning LSB ^e	102	Real Time Tx Power MSB ^g		
24	Tx Power H Alarm MSB ^g	103	Real Time Tx Power LSB ^g		
25	Tx Power H Alarm LSB ^g				

- a. Temperature (Temp) is decoded as a 16-bit signed two's complement integer in increments of 1/256°C.
- b. Received average optical power (Rx Pwr) is decoded as a 16-bit unsigned integer in increments of $0.1~\mu W$.
- c. Supply voltage (Vcc) is decoded as a 16-bit unsigned integer in increments of 100 μV .
- d. Bytes 56-94 are not intended for use, but have been set to default values per SFF-8472.
- e. Tx bias current (Tx Bias) is decoded as a 16 bit unsigned integer in increments of 2 μ A.
- f. Byte 95 is a checksum calculated (per SFF-8472) and stored prior to product shipment.
- g. Transmitted average optical power (Tx Pwr) is decoded as a 16-bit unsigned integer in increments of 0.1 μ W.

Table 18: EEPROM Serial ID Memory Contents - Soft Commands (Address A2h, Byte 110)

Bit Number	Status/Control Name	Description	Notes
7	TX_DISABLE State	Digital state of TX_DISABLE Input Pin (1 = TX_DISABLE asserted)	а
6	Soft TX_DISABLE Control	Read/write bit for changing digital state of TX_DISABLE function	a, b
5	RS(1) State	Digital state of TX Rate_Select Input Pin (1 = RS(1) asserted)	
4	RS(0) State	Digital state of RX Rate_Select Input Pin (1 = RS(0) asserted)	
3	RS(0) RX_RATE_SELECT Control	Read/write bit for changing digital state of Rx Rate_Select RS(0)	С
2	TX_FAULT State	Digital state of TX_FAULT Output Pin (1 = TX_FAULT asserted)	а
1	RX_LOS State	Digital state of SFP RX_LOS Output Pin (1 = RX_LOS asserted)	а
0	Data Ready (Bar)	Indicates transceiver is powered and real time sense data is ready (0 = Data Ready)	

- a. The response time for soft commands of the AFBR-735ASMZ is 100 ms as specified by MSA.
- b. Bit 6 is logic ORed with the SFP TX_DISABLE input pin 3 either asserted will disable the SFP transmitter.
- c. Bit 3 is logic ORed with the SFP RS(0) RX Rate_Select input pin 7 either asserted will set receiver to Rate = High. The power-on default is logic zero/low.

Table 19: EEPROM Serial ID Memory Contents - Alarms and Warnings (Address A2h, Bytes 112, 113, 116, 117)

Byte	Bit	Flag Bit Name	Description
112	7	Temp High Alarm	Set when transceiver internal temperature exceeds high alarm threshold.
	6	Temp Low Alarm	Set when transceiver internal temperature exceeds low alarm threshold.
	5	Vcc High Alarm	Set when transceiver internal supply voltage exceeds high alarm threshold.
	4	Vcc Low Alarm	Set when transceiver internal supply voltage exceeds low alarm threshold.
	3	Tx Bias High Alarm	Set when transceiver laser bias current exceeds high alarm threshold.
	2	Tx Bias Low Alarm	Set when transceiver laser bias current exceeds low alarm threshold.
	1	Tx Power High Alarm	Set when transmitted average optical power exceeds high alarm threshold.
	0	Tx Power Low Alarm	Set when transmitted average optical power exceeds low alarm threshold.
113	7	Rx Power High Alarm	Set when received average optical power exceeds high alarm threshold.
	6	Rx Power Low Alarm	Set when received average optical power exceeds low alarm threshold.
	0–5	reserved	
116	7	Temp High Warning	Set when transceiver internal temperature exceeds high warning threshold.
	6	Temp Low Warning	Set when transceiver internal temperature exceeds low warning threshold.
	5	Vcc High Warning	Set when transceiver internal supply voltage exceeds high warning threshold.
	4	Vcc Low Warning	Set when transceiver internal supply voltage exceeds low warning threshold.
	3	Tx Bias High Warning	Set when transceiver laser bias current exceeds high warning threshold.
	2	Tx Bias Low Warning	Set when transceiver laser bias current exceeds low warning threshold.
	1	Tx Power High Warning	Set when transmitted average optical power exceeds high warning threshold.
	0	Tx Power Low Warning	Set when transmitted average optical power exceeds low warning threshold.
117	7	Rx Power High Warning	Set when received average optical power exceeds high warning threshold.
	6	Rx Power Low Warning	Set when received average optical power exceeds low warning threshold.
	0–5	reserved	

Table 20: EEPROM Serial ID Memory Contents - Soft Commands (Address A2h, Byte 118)

Bit Number	Status/Control Name	Description	Notes
4–7	Reserved		
3	RS(1) TX_RATE_SELECT Control	Read/write bit for changing digital state of Tx Rate_Select RS(1) function	а
2	Reserved		
1	Power Level State	Always set to zero. Value of zero indicates Power Level 1 operation (1W max.).	
0	Power Level Select	Unused. This device supports power level zero (1W max.) only.	

a. Bit 3 is logic ORed with the SFP RS(1) TX Rate_Select input pin 9....either asserted will set transmitter to Rate = High. The power-on default is logic zero/low.

Table 21: EEPROM Serial ID Memory Contents - CDR Loss of Lock (LOL) Status Indicators (Address A2h, Byte 119)

Bit Number	Status/Control Name	Description
7–2	Reserved	
1	Tx CDR LOL Flag	A value of 0 indicates the CDR is locked. A value of 1 indicates CDR loss of lock.
0	Rx CDR LOL Flag	A value of 0 indicates the CDR is locked. A value of 1 indicates CDR loss of lock.

Table 22: EEPROM Serial ID Memory Contents - Transmitter Input Electrical Equalization Control (Address A2h, Byte 114)

Bit Number	Status/Control Name	Description
7–4	TX EQ	Selects an input equalization value per Table 9-13 of SFF-8472, RS1 = High
3–0	Reserved	

From Table 9-13 of SFF-8472.

Table 23: Transmitter Input Equalization Control Values (Address A2h, Byte 114)

	Transmitter Input Equalization	
Code	Nominal	Units
11xx	Reserved	
1011	Reserved	
1010	10	dB
1001	9	dB
1000	8	dB
0111	7	dB
0110	6	dB
0101	5	dB
0100	4	dB
0011	3	dB
0010	2	dB
0001	1	dB
0000	0	No Equalization

Table 24: EEPROM Serial ID Memory Contents – Receiver Output Electrical Emphasis Control (Address A2h, Byte 115)

Bit Number	Status/Control Name	Description	
7–4	RX EMPH	Selects an output emphasis value per Table 9-14 of SFF-8472, RS0 = High	
3–0	Reserved		

From Table 9-14 of SFF-8472.

Table 25: Receiver Output Emphasis Control Values (Address A2h, Byte 115)

	Receiver Output Emphasis At Nominal Output Amplitude	
Code	Nominal	Units
1xxx	Vendor Specific	
0111	7	dB
0110	6	dB
0101	5	dB
0100	4	dB
0011	3	dB
0010	2	dB
0001	1	dB
0000	0	No Emphasis

Figure 8: Module Drawing

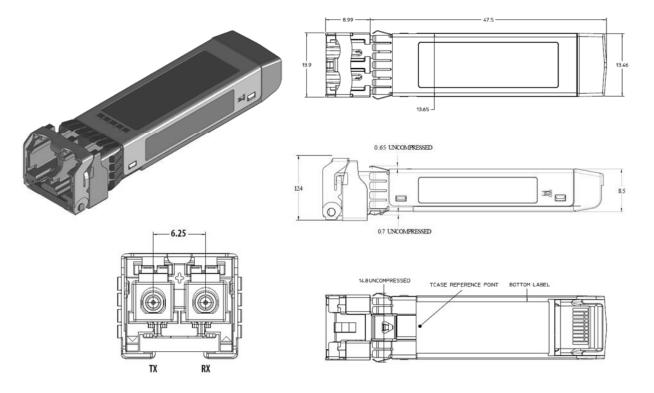


Figure 9: Module Label



Customer Manufacturing Processes

This module is pluggable and is not designed for aqueous wash, IR reflow, or wave soldering processes.

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